

IN THE CLAIMS:

The following is a complete listing of the claims in this application, reflects all changes currently being made to the claims, and replaces all earlier versions and all earlier listings of the claims:

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1. (Currently Amended) A forming method for forming manufacturing an ink jet print head ~~substrate~~ in which an ink flow path ~~forming member is attached to~~ is formed by contacting a substrate for forming an ink discharge pressure generating discharging energy generating element, wherein a pit is formed in an attachment region of the substrate for attaching the liquid flow path forming member with an ink flow path forming member for forming the ink flow path, said method comprising the steps of:

providing a layer on the substrate, at least a portion of the layer being polyether amide resin;

forming a pit on the substrate by performing anisotropic etching of the layer as an etching mask; and

providing the ink flow path forming member on the substrate so that the ink flow path forming member is in contact with the pit on the substrate.

2.-4. (Canceled)

5. (Currently Amended) An ink jet print head substrate formed by the method of an ink jet print head substrate according to ~~any one of claims 1 to 4~~ claim 1.